NOTE: R14 AND C10 CAN BE DNI FOR BASE VERSION OF TCAN1042 (H, G, HG VERSIONS) BECAUSE PIN 5 IS A NC.

NOTE: INSTALL R10 FOR VISO = 5V. OTHERWISE INSTALL R13 FOR VISO = 3V.

NOTE: USE AN 8MM ISOLATION GAP ON THE PCB WITH AN FR4 CAPACITOR STITCH TO IMPROVE EMMISIONS.

NOTE: INSTALL R12 IF USING A DIFFERENT TI CAN TRANSCEIVER THAT USES PIN 5 AS AN INPUT. (EX. TCAN330 PIN 5 = SHDN)

NOTE: THE 4.99K PULLUP AND PULL DOWN RESISTORS HAVE BEEN ADDED FOR EVALUATION CONVENIENCE, BUT ARE NOT REQUIRED FOR FINAL APPLICATIONS.

NOTE: INSTALL R15 FOR VISO = 5V, OTHERWISE INSTALL R13 FOR VISO = 3V.

NOTE: INSTALL R14 AND C10: CAN AS IN (H, G, HG VERSIONS) BECAUSE PIN 5 IS A NC.
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